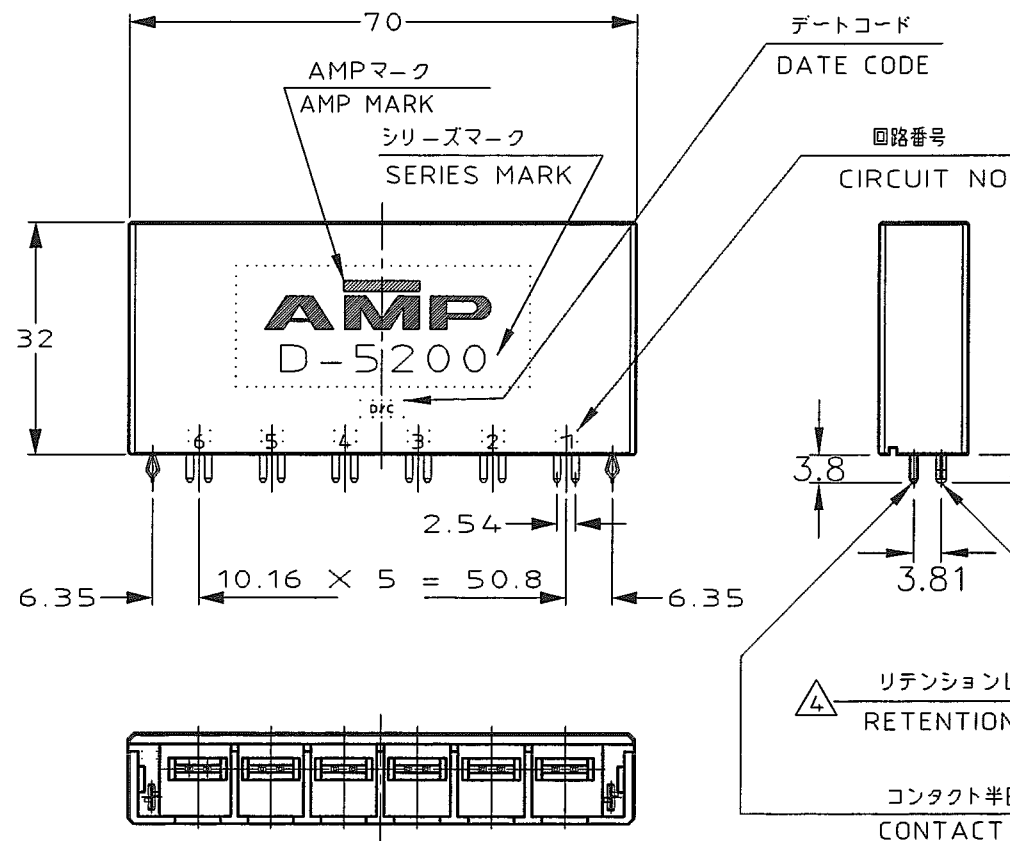
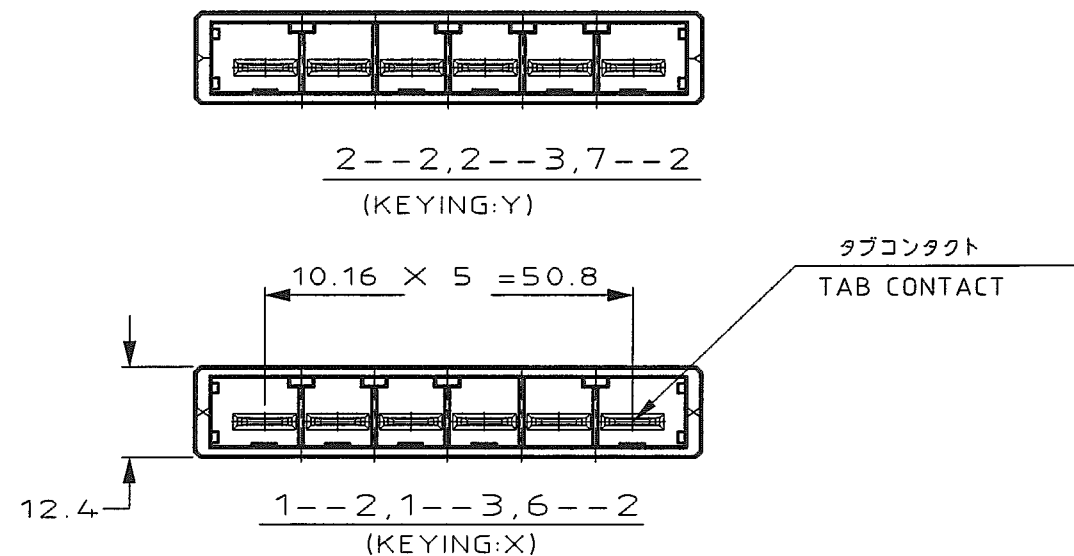
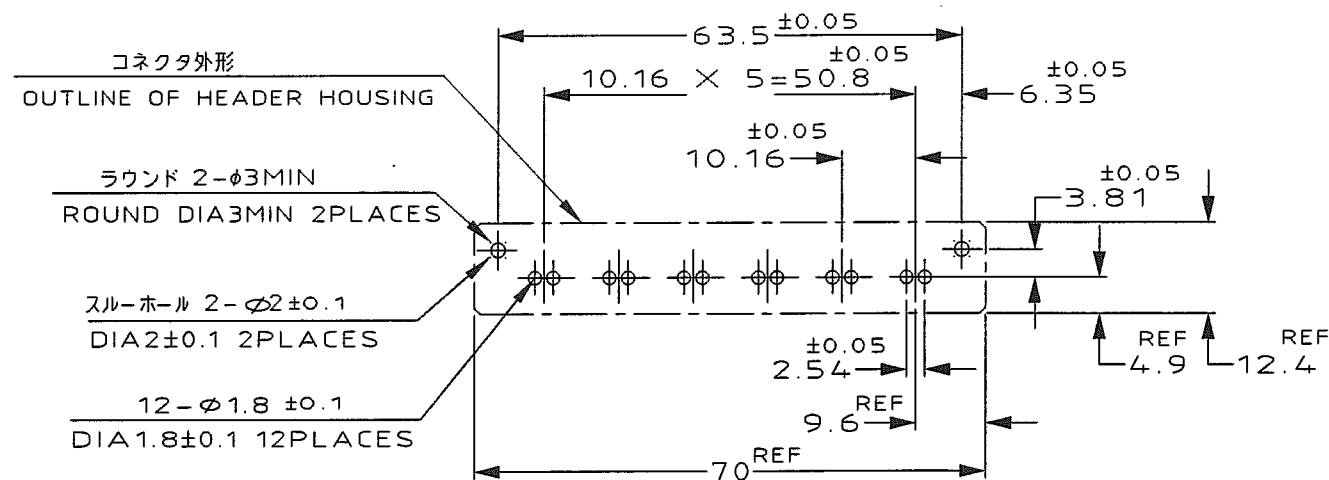




Y	△4	△3	2-179960-3
	△4	△2	7-179960-2
	△4	△2	2-179960-2
X	△4	△3	1-179960-3
	△4	△2	6-179960-2
	△4	△2	1-179960-2
KEY TYPE	コンタクトのめっき (FINISH)		製品番号 (PART NO.)



推奨基板取付け穴寸法
PC 基板厚: 1.6 ~ 2.4 ±0.1
(非累積公差)
(コネクタ搭載面)
PC 基板厚: 3.2 ±0.1
6,7-179960-2 ONLY

RECOMENDED PC BOARD HOLE PATTERN
PC BOARD THICKNESS: 1.6 ~ 2.4 ±0.1
(NOT ACCUMULATE TOLERANCE)
(CONNECTOR MOUNT SIDE)
PC BOARD THICKNESS: 3.2 ±0.1
6,7-179960-2 ONLY

- NOTES
- MATERIAL: HOUSING: GLASS FILLED THERMO PLASTIC, POLYESTER(94V-0), COLOR: BLACK
TAB CONTACT: COPPER ALLOY
RETENTION LEG: BRASS
 - FINISH (CONTACT AREA): 0.38μm Min. PdNi & GOLD FLASH
 - FINISH (CONTACT AREA): 0.76μm Min. PdNi & GOLD FLASH
 - FINISH (RETENTION LEG): TIN PLATED (CONTACT TAIL) OVER NICKEL

F	REVISED PER ECN-26-376948	FZ	LL	19MAR 2026
E2	REVISED PER ECO-11-005030	RK	HMR	23MAR11
LTR	REVISION RECORD	DR	CHK	DATE

				 TE Connectivity		
WIRE RANGE		INSULATION DIA		NAME 6極 1列 垂直タイプ ヘッダー アッシー		
mm² (AWG -)		mmφ		6 POS SINGLE ROW VERTICAL HDR ASS'Y		
MATERIAL SEE NOTE 注記参照		FINISH SEE NOTE 注記参照		<DYNAMIC D-5200>		
DR. 14/APR/'95		DE. 14/APR/'95		一般公差 (GENERAL TOLERANCE)	SIZE	LOC
Y.Ishikawa		Y.Ishikawa		100% ±0.3 100% 300% ±0.35 300% 1000% ±0.4 角 度 ±3'	A3	J
CHK. 17/APR/'95		APP. 17/APR/'95		S.Manabe	SCALE	REV.
				S.Manabe	1-1	F
					SHEET	1 of 1

TE Connectivity

C=179960